

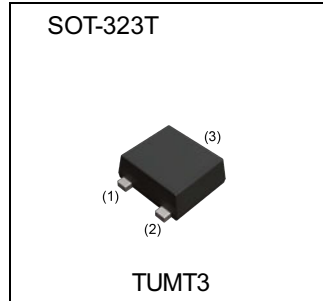


THE DATASHEET OF 2SB1732TL



| Parameter | Value |
|-----------|-------|
| V_{CEO} | -12V |
| I_C | -1.5A |

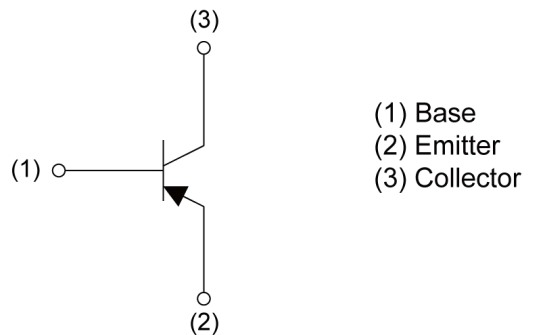
●Outline



●Features

- 1)A collector current is large.
- 2)Collector-Emitter saturation voltage is low.
 $V_{CE(sat)} \leq -200mV$
at $I_C = -500mA / I_B = -25mA$

●Inner circuit



●Application

LOW FREQUENCY AMPLIFIER

●Packaging specifications

| Part No. | Package | Package size | Taping code | Reel size (mm) | Tape width (mm) | Quantity (pcs) | Marking |
|----------|------------------|--------------|-------------|----------------|-----------------|----------------|---------|
| 2SB1732 | SOT-323T (TUMT3) | 2021 | TL | 180 | 8 | 3000 | EV |

● **Absolute maximum ratings** ($T_a = 25^\circ\text{C}$)

| Parameter | Symbol | Values | Unit |
|------------------------------|----------------------|-------------|------------------|
| Collector-base voltage | V_{CBO} | -15 | V |
| Collector-emitter voltage | V_{CEO} | -12 | V |
| Emitter-base voltage | V_{EBO} | -6 | V |
| Collector current | I_{C} | -1.5 | A |
| | I_{CP}^{*1} | -3 | A |
| Power dissipation | P_{D}^{*2} | 400 | mW |
| | P_{D}^{*3} | 800 | mW |
| Junction temperature | T_{j} | 150 | $^\circ\text{C}$ |
| Range of storage temperature | T_{stg} | -55 to +150 | $^\circ\text{C}$ |

● **Electrical characteristics** ($T_a = 25^\circ\text{C}$)

| Parameter | Symbol | Conditions | Values | | | Unit |
|--------------------------------------|----------------------|---|--------|------|------|------|
| | | | Min. | Typ. | Max. | |
| Collector-base breakdown voltage | BV_{CBO} | $I_{\text{C}} = -10\mu\text{A}$ | -15 | - | - | V |
| Collector-emitter breakdown voltage | BV_{CEO} | $I_{\text{C}} = -1\text{mA}$ | -12 | - | - | V |
| Emitter-base breakdown voltage | BV_{EBO} | $I_{\text{E}} = -10\mu\text{A}$ | -6 | - | - | V |
| Collector cut-off current | I_{CBO} | $V_{\text{CB}} = -15\text{V}$ | - | - | -100 | nA |
| Emitter cut-off current | I_{EBO} | $V_{\text{EB}} = -6\text{V}$ | - | - | -100 | nA |
| Collector-emitter saturation voltage | $V_{\text{CE(sat)}}$ | $I_{\text{C}} = -500\text{mA}$, $I_{\text{B}} = -25\text{mA}$ | - | -85 | -200 | mV |
| DC current gain | h_{FE} | $V_{\text{CE}} = -2\text{V}$, $I_{\text{C}} = -200\text{mA}$ | 270 | - | 680 | - |
| Transition frequency | f_{T} | $V_{\text{CE}} = -2\text{V}$, $I_{\text{E}} = 200\text{mA}$, $f = 100\text{MHz}$ | - | 400 | - | MHz |
| Output capacitance | C_{ob} | $V_{\text{CB}} = -10\text{V}$, $I_{\text{E}} = 0\text{A}$, $f = 1\text{MHz}$ | - | 12 | - | pF |

*1 $P_w=1\text{ms}$, Single pulse

*2 Each terminal mounted on a reference land.

*3 Mounted on a ceramic board(25×25×0.8mm).

● Electrical characteristic curves ($T_a = 25^\circ\text{C}$)

Fig.1 Grounded emitter propagation characteristics

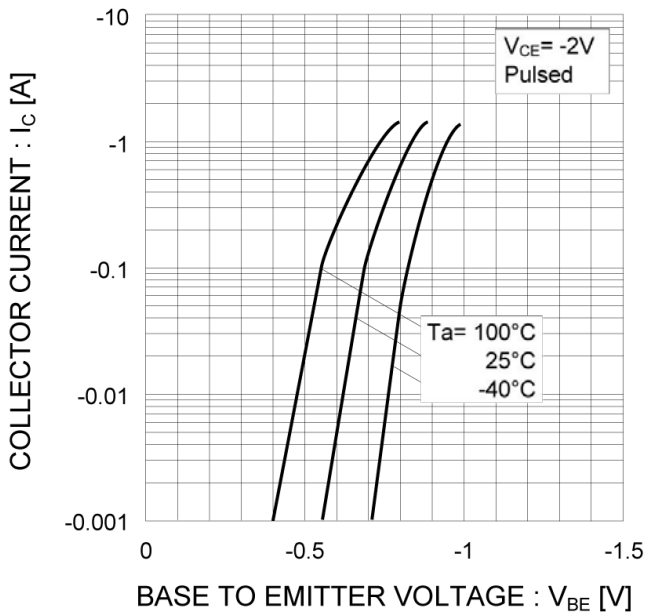


Fig.2 Typical output characteristics

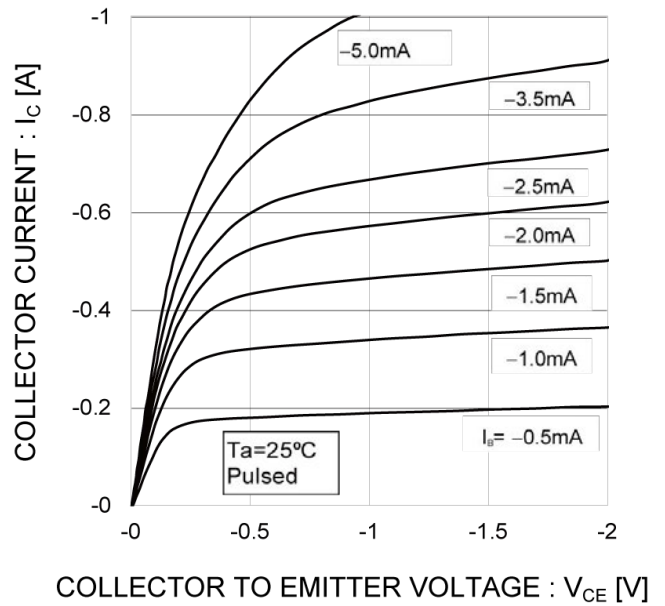


Fig.3 DC current gain vs. collector current (I)

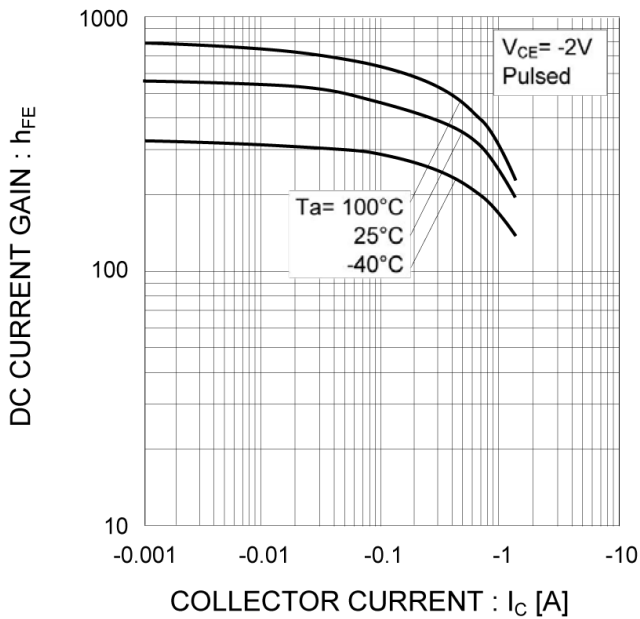
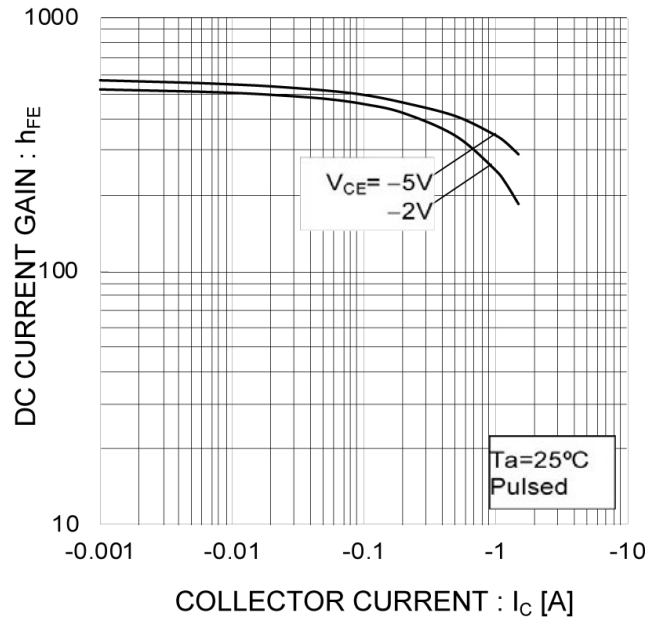


Fig.4 DC current gain vs. collector current (II)



● Electrical characteristic curves ($T_a = 25^\circ\text{C}$)

Fig.5 Collector-emitter saturation voltage vs. collector current (I)

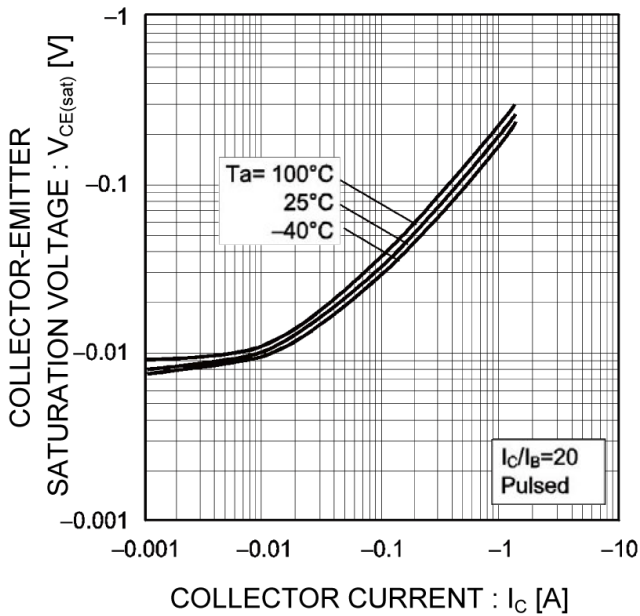


Fig.6 Collector-emitter saturation voltage vs. collector current (II)

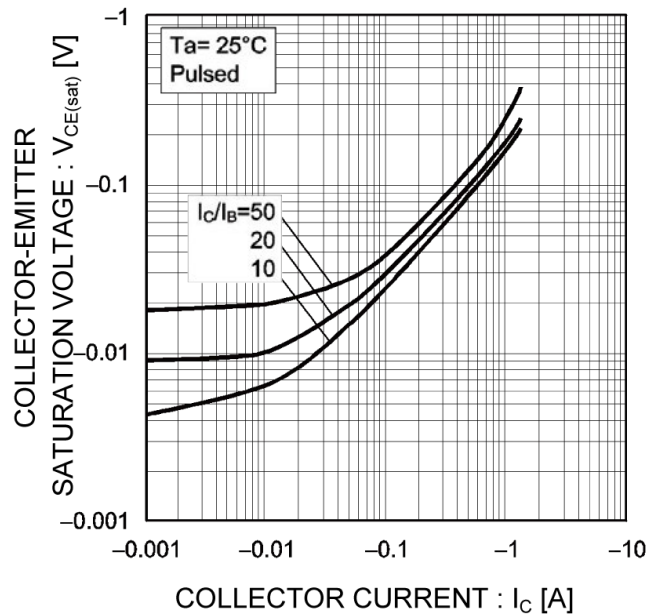


Fig.7 Base-emitter saturation voltage vs. collector current

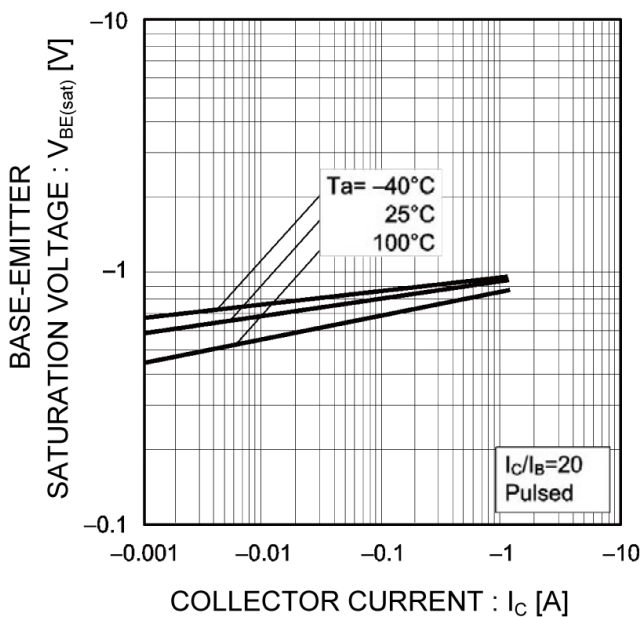
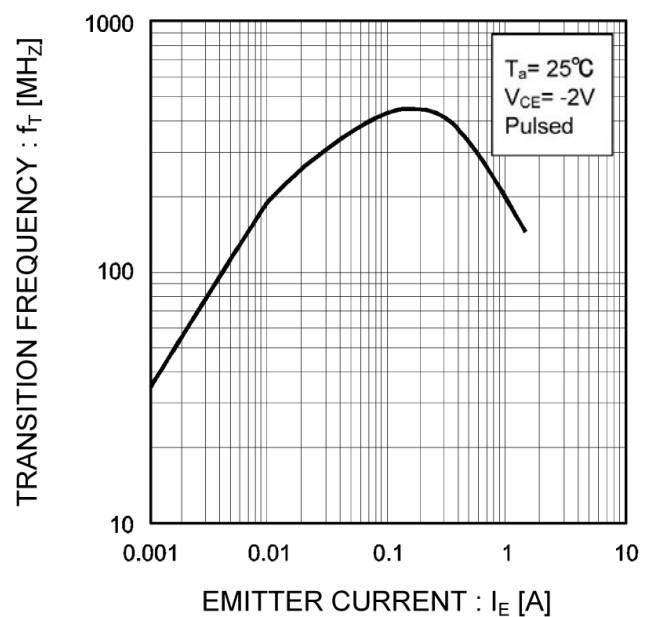


Fig.8 Gain bandwidth product vs. emitter current



●Electrical characteristic curves($T_a = 25^\circ\text{C}$)

Fig.9 Collector output capacitance vs. collector-base voltage
 Emitter input capacitance vs. emitter-base voltage

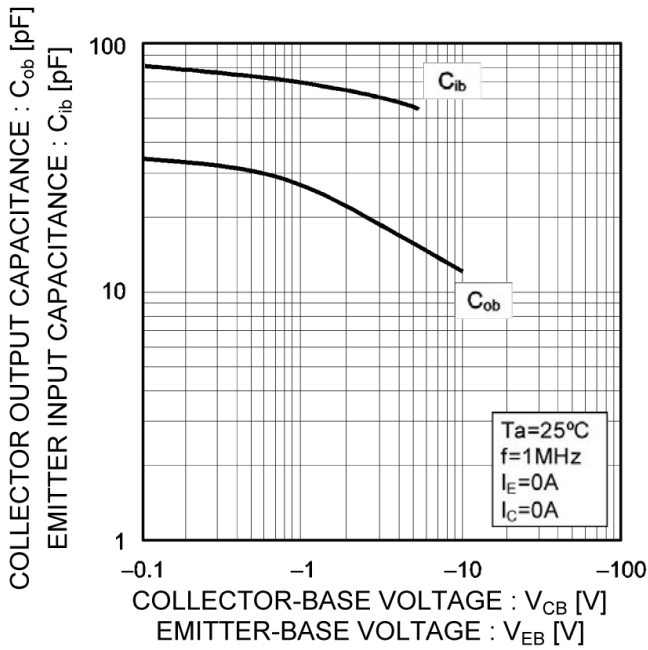
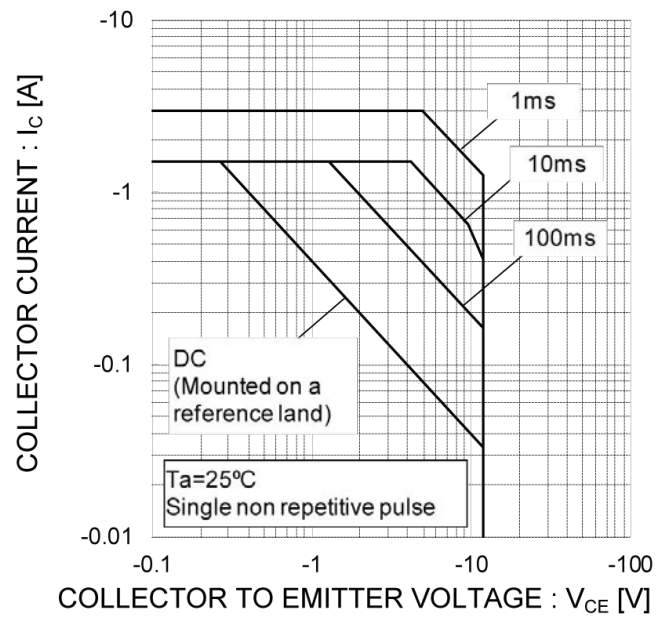
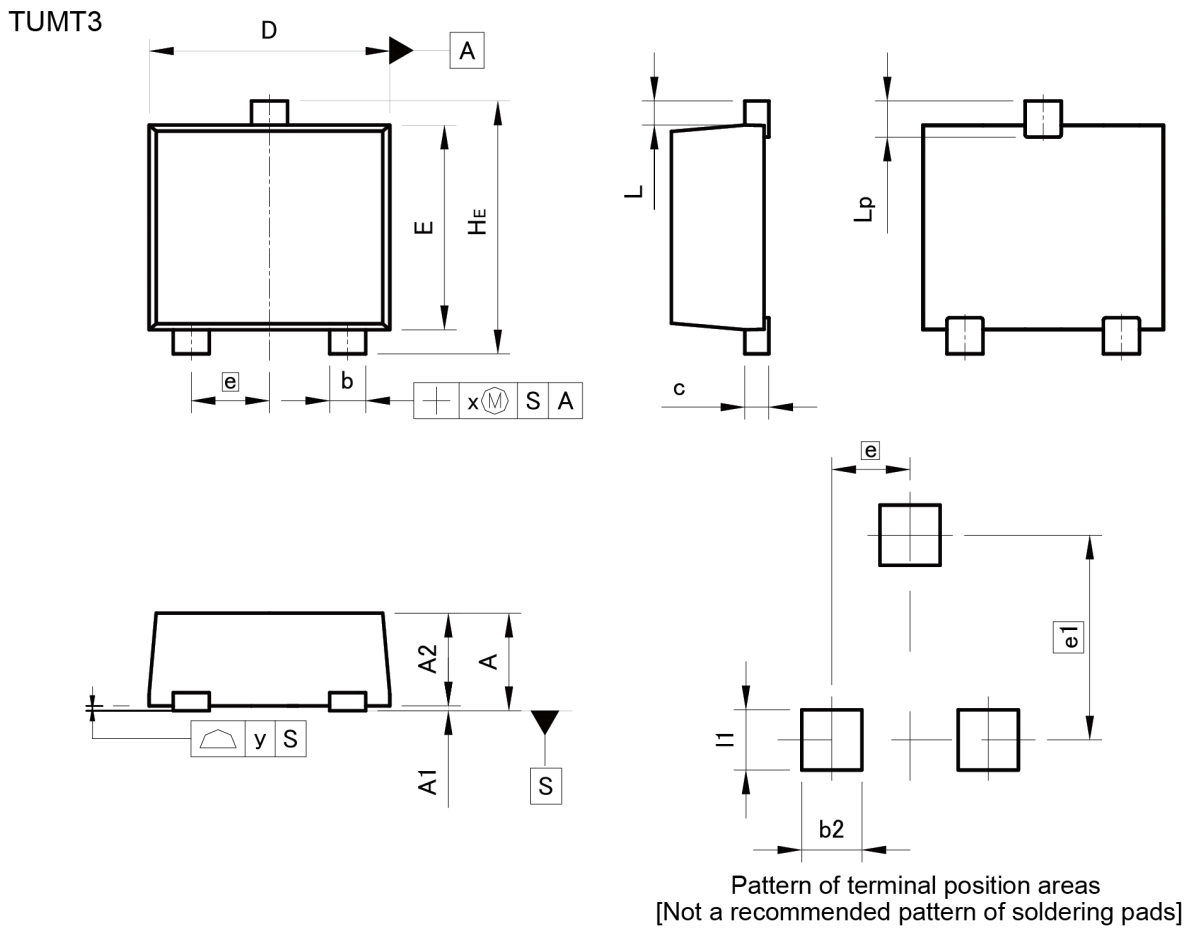


Fig.10 Safe operating area



●Dimensions



| DIM | MILIMETERS | | INCHES | |
|-----|------------|------|--------|-------|
| | MIN | MAX | MIN | MAX |
| A | - | 0.85 | - | 0.033 |
| A1 | 0.00 | 0.10 | 0.000 | 0.004 |
| A2 | 0.72 | 0.82 | 0.028 | 0.032 |
| b | 0.25 | 0.40 | 0.010 | 0.016 |
| c | 0.12 | 0.22 | 0.005 | 0.009 |
| D | 1.90 | 2.10 | 0.075 | 0.083 |
| E | 1.60 | 1.80 | 0.063 | 0.071 |
| e | 0.65 | | 0.026 | |
| HE | 2.00 | 2.20 | 0.079 | 0.087 |
| L | 0.20 | | 0.008 | |
| Lp | - | 0.40 | - | 0.016 |
| x | - | 0.10 | - | 0.004 |
| y | - | 0.10 | - | 0.004 |

| DIM | MILIMETERS | | INCHES | |
|-----|------------|------|--------|-------|
| | MIN | MAX | MIN | MAX |
| b2 | - | 0.50 | - | 0.020 |
| e1 | 1.70 | | 0.067 | |
| l1 | - | 0.50 | - | 0.020 |

Dimension in mm/inches

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(Note1) Medical Equipment Classification of the Specific Applications

| JAPAN | USA | EU | CHINA |
|-----------|-----------|------------|-----------|
| CLASS III | CLASS III | CLASS II b | CLASS III |
| CLASS IV | | CLASS III | |

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 - Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
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 - Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - Sealing or coating our Products with resin or other coating materials
 - Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.) ; or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - Use of the Products in places subject to dew condensation
- The Products are not subject to radiation-proof design.
- Please verify and confirm characteristics of the final or mounted products in using the Products.
- In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- Confirm that operation temperature is within the specified range described in the product specification.
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- When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of Ionizer, friction prevention and temperature / humidity control).

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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
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4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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